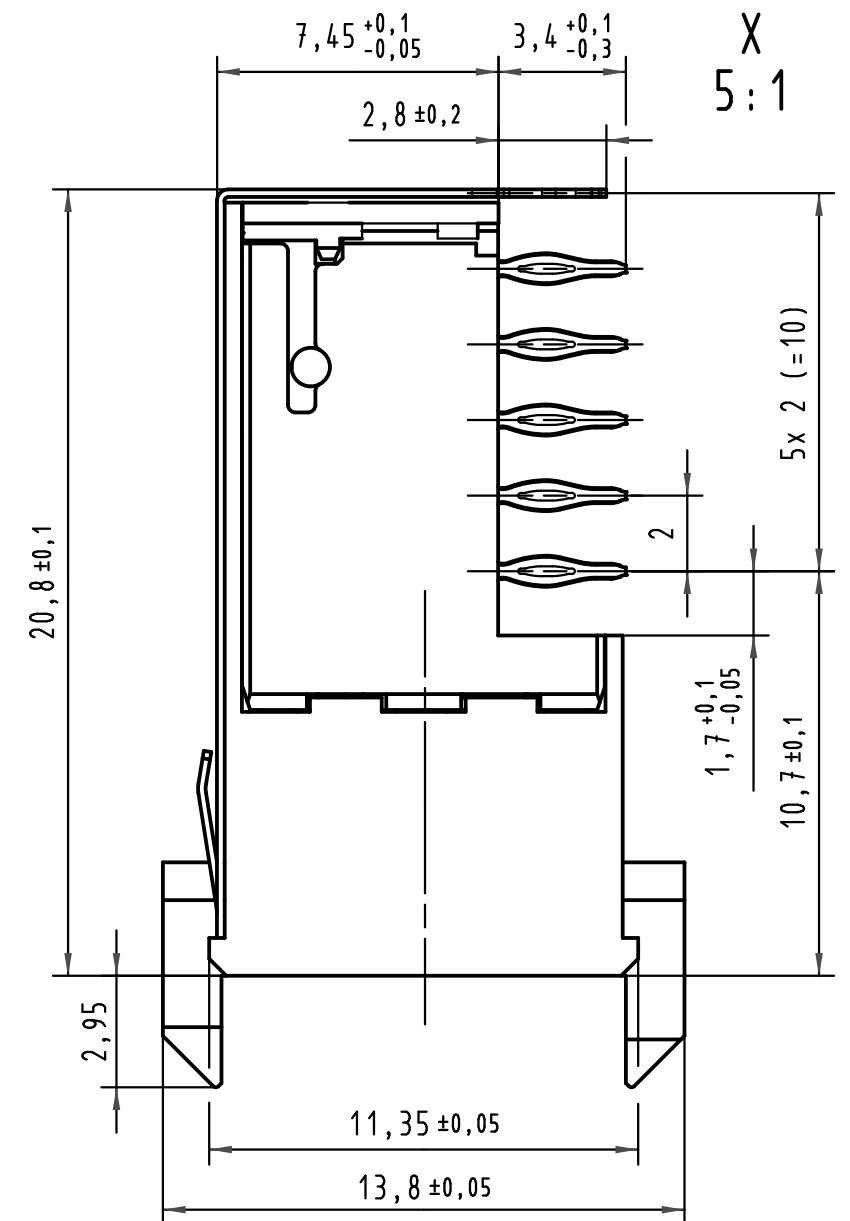
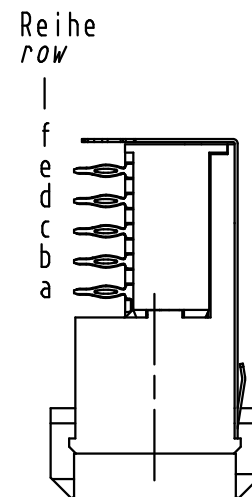
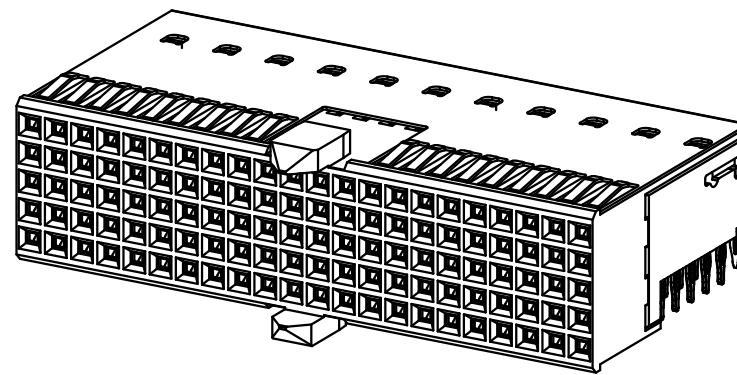
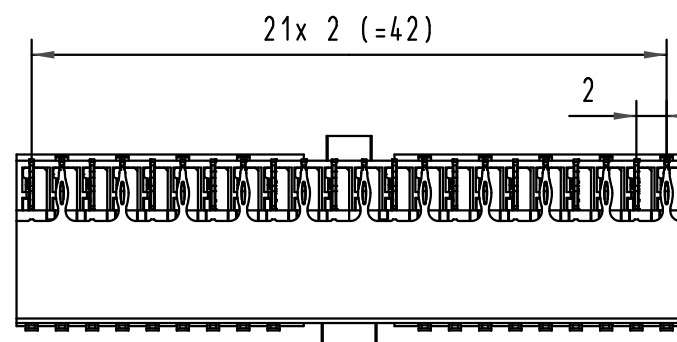
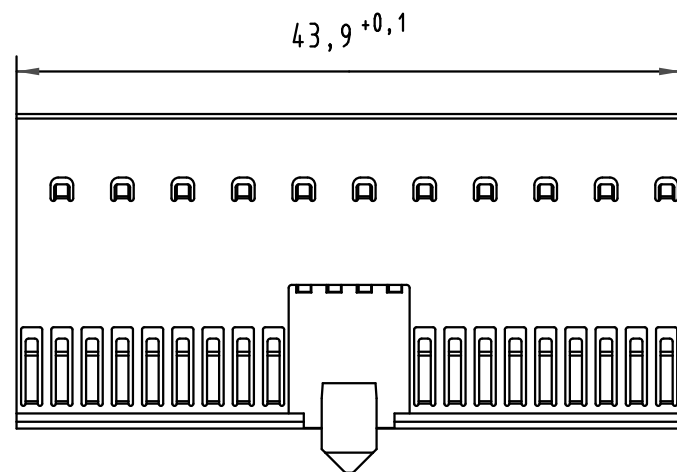
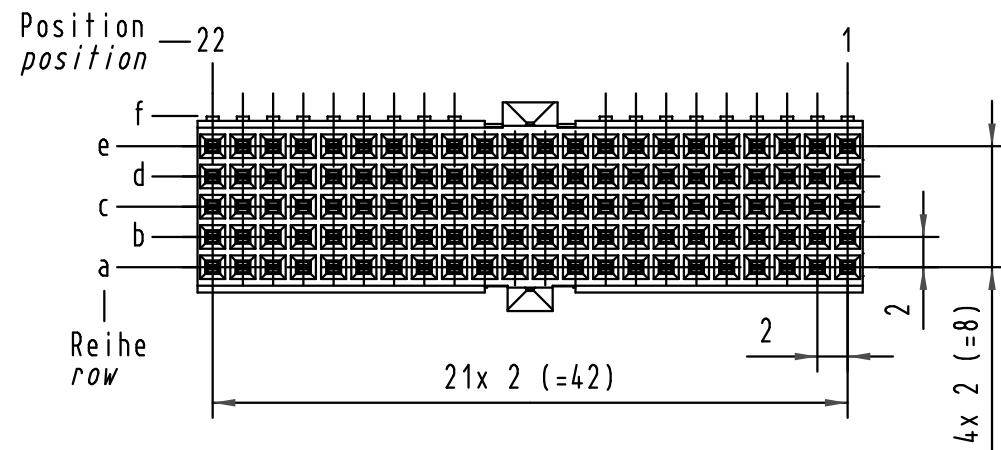
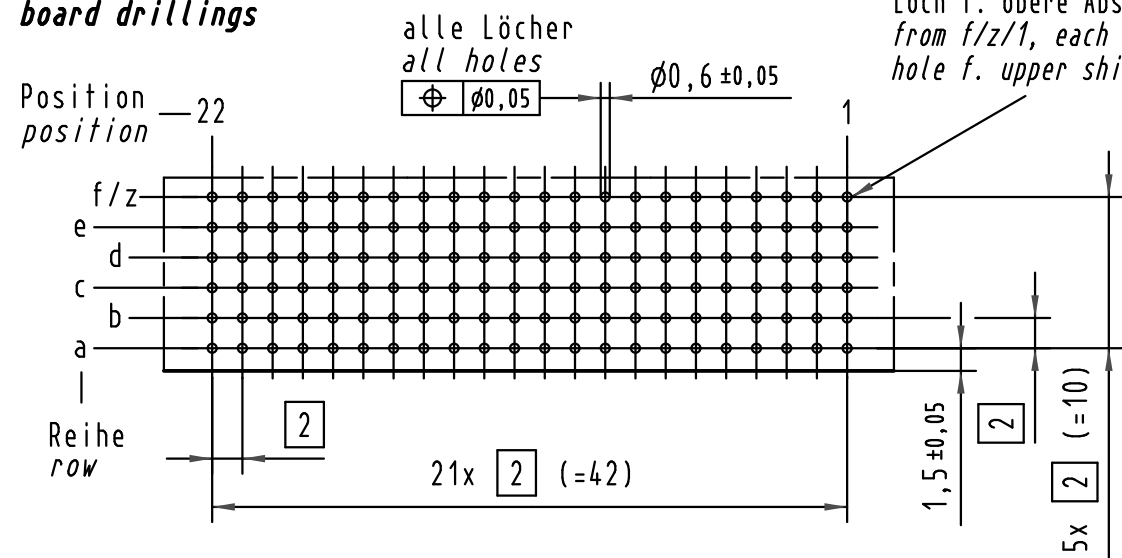




Lochbild board drillings



Von f/z/1 aus, jedes 2.
Loch f. obere Abschirmung
from f/z/1, each 2nd
hole f. upper shielding

Bohrlochdurchmesser: $\phi 0,7 \pm 0,02$ mm
Lochdurchmesser (mit Oberfläche): $\phi 0,6 \pm 0,05$ mm
drill hole dia.: $\phi 0,7 \pm 0,02$ mm
through hole dia. (after plating): $\phi 0,6 \pm 0,05$ mm

17 34 110 4102	—	min. $0,76 \mu\text{m}$ ($30 \mu\text{m}$) Au über/over min. $1,27 \mu\text{m}$ ($50 \mu\text{m}$) Ni
17 34 110 2102	2	Au über/over Ni
17 34 110 1102	1	Au über/over Ni
Bestell-Nr. part-no.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maße/Free size tolerances IEC 61076-4-101	
				Dat.	Name	Maßstab/Scale	
				Detail.	01.06.01	Hm	2:1 (5:1)
				Insp.	01.06.01	Ko	
				Stand.			
35456	01.12.08	TD	HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP			har-bus HM Federleiste, Typ AB-22, 110 pol. mit Schirmblech Reihe-f har-bus HM female connector, type AB-22, 110 pol. with shield row-f	TB 17 34 110 x102
32387	19.11.04	HL.					
27619							
Mod.	Dat.	Name				Sub.	Blatt/ page